SN5433, SN54LS33, SN7433, SN74LS33 QUADRUPLE 2 INPUT POSITIVE NOR BUFFERS WITH OPEN-COLLECTOR OUTPUTS

SDLS101

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

These devices contain four independent 2-input NOR buffer gates with open-collector outputs. Open-collector outputs require resistive pull-up to perform logically but can deliver higher V_{OH} levels and are commonly used in wired-AND applications.

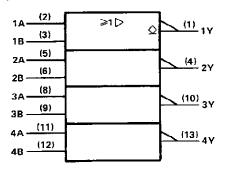
The SN5433 and SN54LS33 are characterized for operation over the full military temperature range of -55 °C to 125 °C. The SN7433, and SN74LS33 are characterized for operation from 0 °C to 70 °C.

FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
A	в	Y
н	х	L
X	н	Ĺ
L	L	H

logic symbol[†]

b



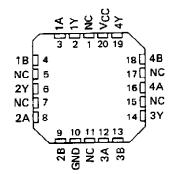
[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

DECEMBER 1983-REVISED MARCH 1988

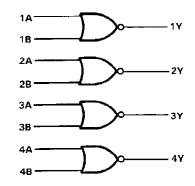
SN7433 . SN74LS33	3JOR W PACKAGE N PACKAGE .DOR N PACKAGE OP VIEW)
1Y [] 1A [] 1B [] 2Y [] 2A [] 5	14 V _{CC} 13 4Y 12 4B 11 4A 10 3Y
2B 🗌 6 GND 🔲 7	9 3B 8 3A

SN54LS33 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram



positive logic

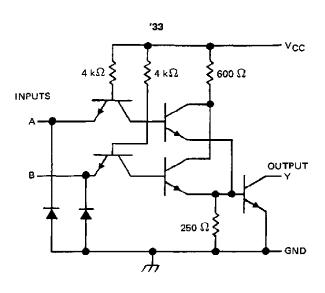
$$Y = \overline{A + B}$$
 or $Y = \overline{A + B}$

PRODUCTION DATA documents centain information current as of publication date. Products conform to specifications par the terms of Texas instruments standard warrenty. Production processing does not necessarily include testing of all parameters.



SN5433, SN54LS33, SN7433, SN74LS33 QUADRUPLE 2-INPUT POSITIVE-NOR BUFFERS WITH OPEN-COLLECTOR OUTPUTS

schematics (each gate)



 $\begin{array}{c} \text{`LS33}\\ \text{INPUTS}\\ \text{A}\\ \text{IVPUTS}\\ \text{IVPUTS}\\$

Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	,
Input voltage: '33	
′LS33	
Offistate output voltage	
Operating free-air temperature: SN54'	
SN74′0°C to 70°C	;
Storage temperature range \ldots	;
DTE 1: Voltage values are with respect to network ground terminal.	



SN5433, SN7433 QUADRUPLE 2-INPUT POSITIVE NOR BUFFERS WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions SN5433 SN7433 UNIT NOM MAX MIN NOM MAX MIN 5 5.5 4.75 5 5.25 v Vcc Supply voltage 4.5 ٧ 2 2 ٧_H High-level input voltage Low-level input voltage 0.8 0.8 ٧ VIL ∨он High-level output voltage 5.5 5.5 v 48 10L Low-level output current 48 mΑ 0 70 ٩Ç Operating free-air temperature -55 125 TΑ

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

BABAMETER		SN5433	\$N7433	UNIT
PARAMETER	TEST CONDITIONS.	MIN TYP [‡] MAX	MIN TYP [‡] MAX	
VIK	$V_{CC} = MIN$, $I_{I} = -12 \text{ mA}$	- 1.5	- 1.5	v
	$V_{CC} = MIN, V_{IL} = 0.8 V, V_{OH} = 5.5 V$		0.25	mA
юн	$V_{CC} = MIN, V_{IL} = 0.7 V, V_{OH} = 5.5 V$	0.25		mA
VOL	$V_{CC} = MIN, V_{IH} \approx 2 V, I_{OL} = 16 mA$	0.2 0.4	0.2 0.4	٧
h li	$V_{CC} = MAX, V_{\parallel} = 5.5 V$	1	1	mA
- <u></u>	$V_{CC} = MAX, V_1 = 2.4 V$	40	40	μA
կլ	$V_{CC} = MAX, V_1 = 0.4 V$	- 1.6	- 1.6	mΑ
ССН	$V_{CC} = MAX, V_{I} = 0$	3 6	3 6	mA
ICCL	V _{CC} = MAX, See Note 2	9 16.5	9 16.5	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. [‡]All typical values are at V_{CC} = 5 V, T_A = 25 °C. NOTE 2: One input at 4.5 V, all others at 0 V.

switching characteristics, VCC = 5 V, TA = 25° C (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	түр	мах	UNIT
tPLH			$P_{1} = 122 + 0$ $C_{2} = 50 - 50$		10	15	ពន
^t PHL	A P	, i	$R_{L} = 133 \text{ k}\Omega, C_{L} = 50 \text{ pF}$		12	18	ns
tPLH	A or B	1	D 10010 0 150 F		15	22	ns
^t PHL			$R_{L} = 133 k\Omega, C_{L} = 150 pF$		16	24	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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SN54LS33, SN74LS33 QUADRUPLE 2-INPUT POSITIVE-NOR BUFFERS WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

	S	N54LS	33	S	N74LS	33	
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{1H} High-level input voltage	2			2			V
VIL Low-level input voltage			0,7			0.8	V
VOH High-level output voltage			5.5	_		5.5	V
IOL Low-level output current			12			24	mΑ
T _A Operating free-air temperature	- 55	_	125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DA DAME TED		TEST CONDIT			N54LS	33	s	N74LS3	33	
PARAMETER				MIN	TYP \$	MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = MIN,	l _† ≃ – 18 mA				- 1.5		-	- 1.5	V
IOH	VCC = MIN,	VIH = 2 V,	VIL = MAX, VOH = 5.5 V			0.25			0.25	mA
Mari	V _{CC} = MIN,	V _{IH} = 2 V,	$V_{IL} = MAX, I_{OL} \approx 12 mA$		0.25	0.4		0.25	0.4	
VOL	V _{CC} = MIN,	VIL = MAX,	l _{OL} ≖ 24 mA					0.35	0.5	V
11	VCC = MAX,	VI = 7 V				0.1			0.1	mΑ
Чн	V _{CC} = MAX,	VI = 2.7 V				20	——		20	μA
IL.	V _{CC} = MAX,	V1 = 0.4 V				- 0,4			- 0.4	mΑ
Іссн	VCC = MAX,	VI = 0		1	1.8	3.6		1.8	3.6	mΑ
ICCL	V _{CC} = MAX,	See Note 2			6.9	13.8		6.9	13.8	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. [‡]All typical values are at V_{CC} = 5 V, T_A = 25 °C. NOTE 2: One input at 4.5 V, all others at 0 V.

switching characteristics, VCC = 5 V, TA = 25° C (see note 3)

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PARAMETER	FROM (INPUT)	то (оuтрит)	TEST CON	IDITIONS	MIN	түр	MAX	UNIT
tPLH	A or B	~	Řι ≈ 667 Ω,	CL = 45 pF		20	32	ns
^t ₽HL	2010	'	····			18	28	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



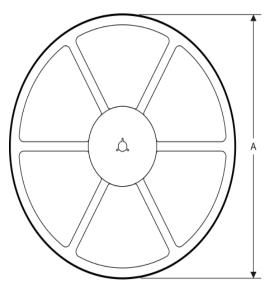
PACKAGE MATERIALS INFORMATION

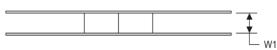
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TAPE AND REEL INFORMATION

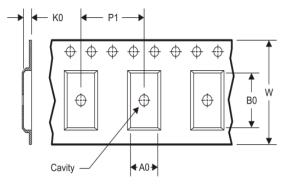
REEL DIMENSIONS

TEXAS INSTRUMENTS





TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	-	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS33DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS33NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

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PACKAGE MATERIALS INFORMATION

14-Jul-2012



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS33DR	SOIC	D	14	2500	367.0	367.0	38.0
SN74LS33NSR	SO	NS	14	2000	367.0	367.0	38.0

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